

G3VM-401B/E

MOS FET Relays

Analog-switching MOS FET Relays with a Dielectric Strength of 2.5 kVAC between I/O Using Optical Isolation.

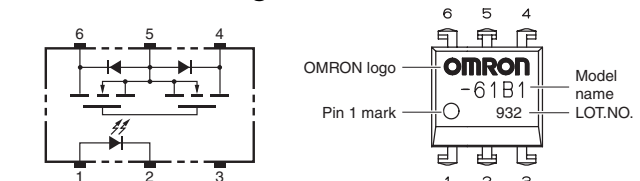
- Switches minute analog signals.
- Leakage current of 1 μA max. when output relay is open.
- Upgraded G3VM-4N Series.

RoHS compliant

Application Examples

- Communication equipment
- Test & Measurement equipment
- Industrial equipment

Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

List of Models

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity	
					Number per tube	Number per tape and reel
DIP6	1a (SPST-NO)	PCB Terminals	400 V	G3VM-401B	50	-
		Surface-mounting Terminals		G3VM-401E		
				G3VM-401E (TR)	-	1,500

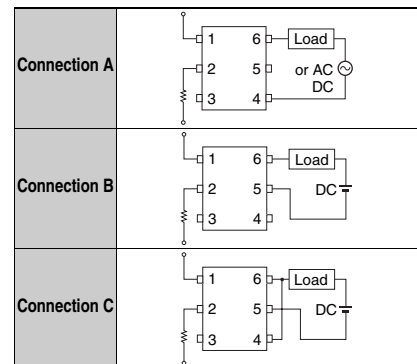
* The AC peak and DC value are given for the load voltage.

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Rating	Unit	Measurement conditions	
Input	LED forward current	IF	50	mA	
	Repetitive peak LED forward current	IFP	1	A	100 μs pulses, 100 pps
	LED forward current reduction rate	$\Delta I_F/\text{°C}$	-0.5	mA/°C	Ta \geq 25°C
	LED reverse voltage	VR	5	V	
	Connection temperature	TJ	125	°C	
Load voltage (AC peak/DC)	V _{OFF}	400	V		
Output	Continuous load current	Connection A	120	mA	Connection A: AC peak/DC Connection B and C: DC
		Connection B	120		
		Connection C	240		
	ON current reduction rate	$\Delta I_o/\text{°C}$	-1.2	mA/°C	Ta \geq 25°C
Connection temperature	TJ	125	°C		
Dielectric strength between I/O (See note 1.)	V _{I-O}	2500	V _{rms}	AC for 1 min	
Ambient operating temperature	Ta	-40 to +85	°C	With no icing or condensation	
Ambient storage temperature	T _{stg}	-55 to +125	°C	With no icing or condensation	
Soldering temperature	-	260	°C	10 s	

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

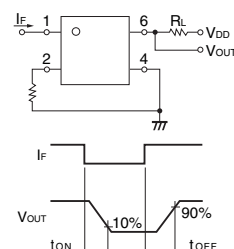
Connection Diagram



Electrical Characteristics (Ta = 25°C)

Item	Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions		
Input	LED forward voltage	V _F	1.0	1.15	1.3	V	I _F = 10 mA	
	Reverse current	I _R	-	-	10	μA	V _R = 5 V	
	Capacity between terminals	C _T	-	30	-	pF	V = 0, f = 1 MHz	
Output	Trigger LED forward current	I _{FT}	-	1	3	mA	I _o = 120 mA	
	Maximum resistance with output ON	R _{ON}	Connection A	-	17	35	Ω	I _F = 5 mA, I _o = 120 mA
			Connection B	-	11	20	Ω	I _F = 5 mA, I _o = 120 mA
			Connection C	-	6	10	Ω	I _F = 5 mA, I _o = 240 mA
	Current leakage when the relay is open	I _{LEAK}	-	-	1.0	μA	V _{OFF} = 400 V	
	Capacity between terminals	C _{OFF}	-	40	-	pF	V = 0, f = 1 MHz	
	Capacity between I/O terminals	C _{I-O}	-	0.8	-	pF	f = 1 MHz, V _s = 0 V	
Insulation resistance between I/O terminals	R _{I-O}	1000	-	-	M Ω	V _{I-O} = 500 VDC, RoH \leq 60%		
Turn-ON time	t _{ON}	-	0.3	1.0	ms	I _F = 5 mA, R _L = 200 Ω , V _{DD} = 20 V (See note 2.)		
Turn-OFF time	t _{OFF}	-	0.1	1.0	ms			

Note: 2. Turn-ON and Turn-OFF Times



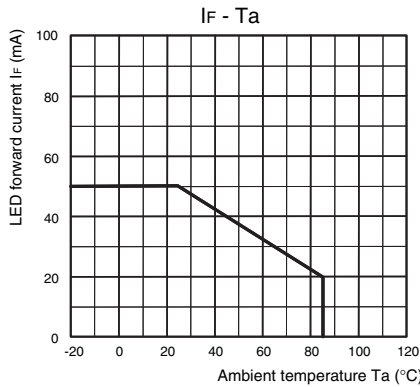
Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

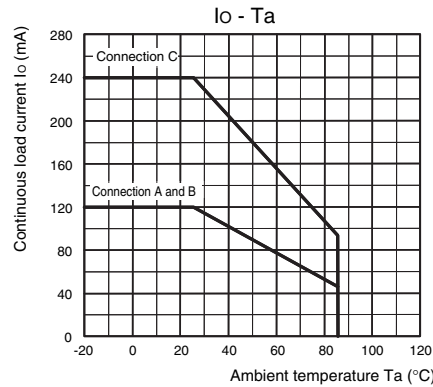
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V _{DD}	-	-	320	V
Operating LED forward current	I _F	5	7.5	25	mA
Continuous load current (AC peak/DC)	I _O	-	-	120	mA
Ambient operating temperature	T _a	-20	-	65	°C

Engineering Data

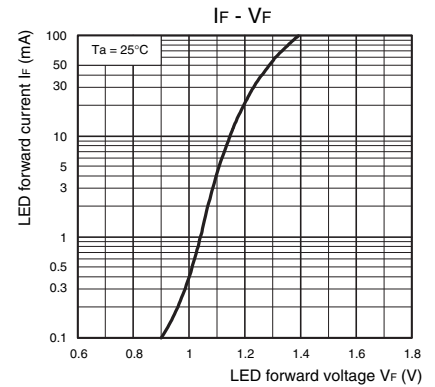
LED forward current vs. Ambient temperature



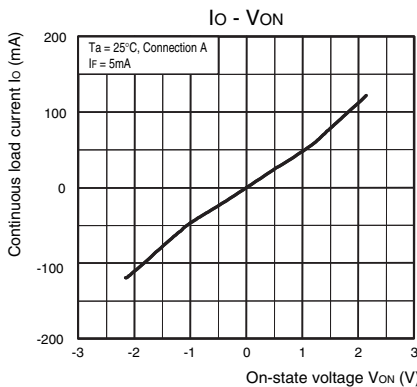
Continuous load current vs. Ambient temperature



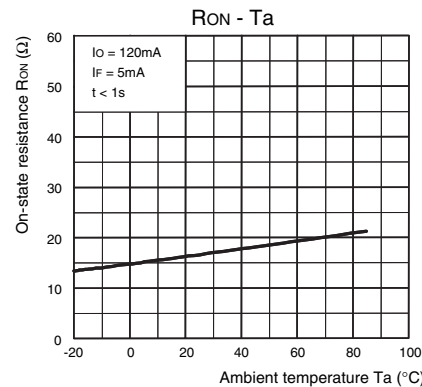
LED forward current vs. LED forward voltage



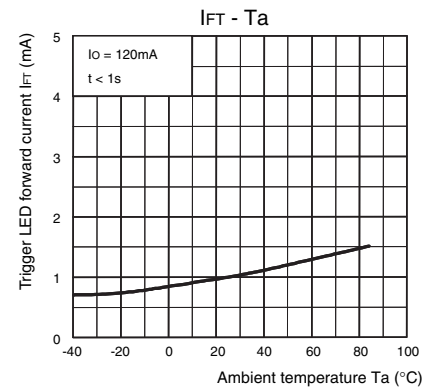
Continuous load current vs. On-state voltage



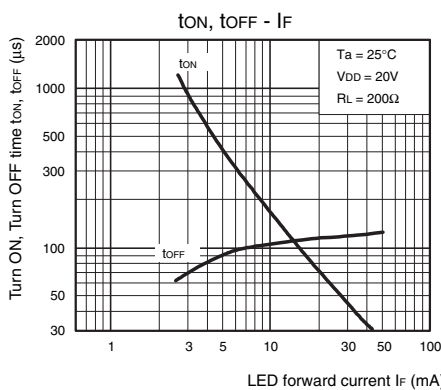
On-state resistance vs. Ambient temperature



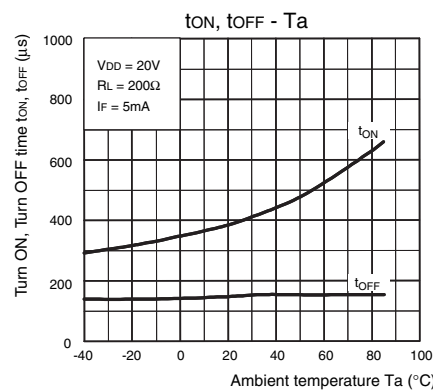
Trigger LED forward current vs. Ambient temperature



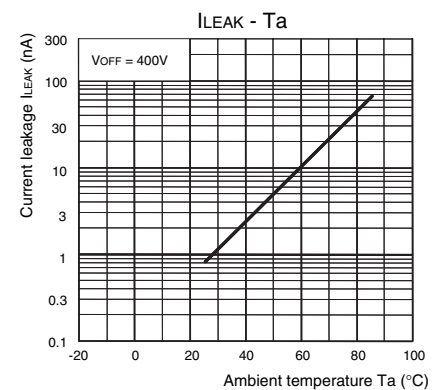
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature

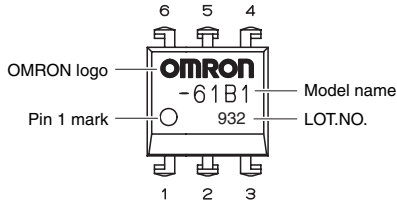


Safety Precautions

- Refer to "Common Precautions" for all G3VM models.

■ Appearance

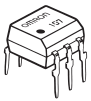
DIP (Dual Inline Package)
DIP6



Note: The actual product is marked differently from the image shown here.

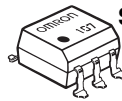
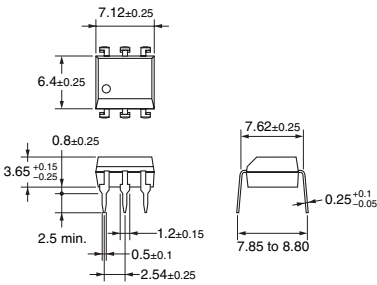
■ Dimensions

(Unit:mm)



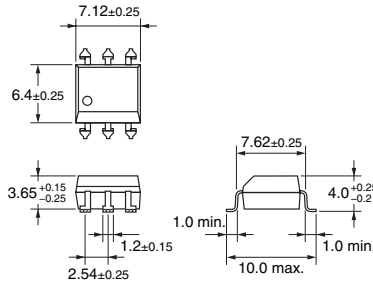
PCB Terminals

Weight: 0.4 g

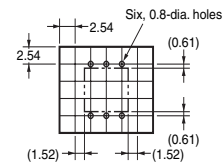


Surface-mounting Terminals

Weight: 0.4 g

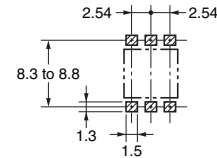


PCB Dimensions (BOTTOM VIEW)



Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)



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- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.